BGA Heat Sink - High Performance maxiFLOW/superGRIP





ATS Part#:

Description:

ATS-X50190B-C1-R0

19.00 x 19.00 x 7.50 mm BGA Heat Sink - High Performance maxiFLOW/superGRIP

Heat Sink Type: Heat Sink Attachmen

Heat Sink Attachment: superGRIP Equivalent Part Number: N/A

*Image above is for illustration purpose only.

Features & Benefits

- Designed for 19 x 19 mm components
- Requires minimal space around the component's perimeter; ideal for densely populated PCBs
- Allows the heat sink to be detached and reattached without damaging the component or the PCB, an important feature in the event a PCB may need to be reworked

maxiFLOW

- Strong, uniform attachment force helps achieve maximum performance from phase-changing TIMs
- Eliminates the need to drill mounting holes in the PCB

Thermal Performance

		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	16.5 °C/W	13.4 °C/W	11.6 °C/W	10.3 °C/W	9.4 °C/W	8.7 °C/W	8.2 °C/W
	Ducted Flow	12.9	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	ТІМ	Finish
	19.00 mm	19.00 mm	7.50 mm	31.5 mm	T766	BLUE-ANODIZED
The above is for illustration purpose only.	 Dimension Thermal papplication ATS resense performar ATS certifier 	rves the right to upda	neight from the bottor e provided for referen ate or change its pro- k assembly is RoHS	nce only. Actual perf ducts without notice -6 and REACH com	ormance to improv	may vary by

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), **sales@qats.com** or **www.qats.com**.

